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Cobalt 71660

4-channel 200 MHz, 16-bit A/D XMC XMC module with Virtex-6 FPGA

Complete radar and software radio interface solution

- Radar and software radio receiver
- Communications receiver
- Analog signal interface for data recording
- Wideband data acquisition
- Remote monitoring
- Sensor interfaces



The 71660 is a multichannel, high-speed data converter, suitable for connection to HF or IF ports of a communications or radar system. Its built-in data capture features offer an ideal turnkey solution as well as a platform for developing and deploying custom FPGA processing IP.

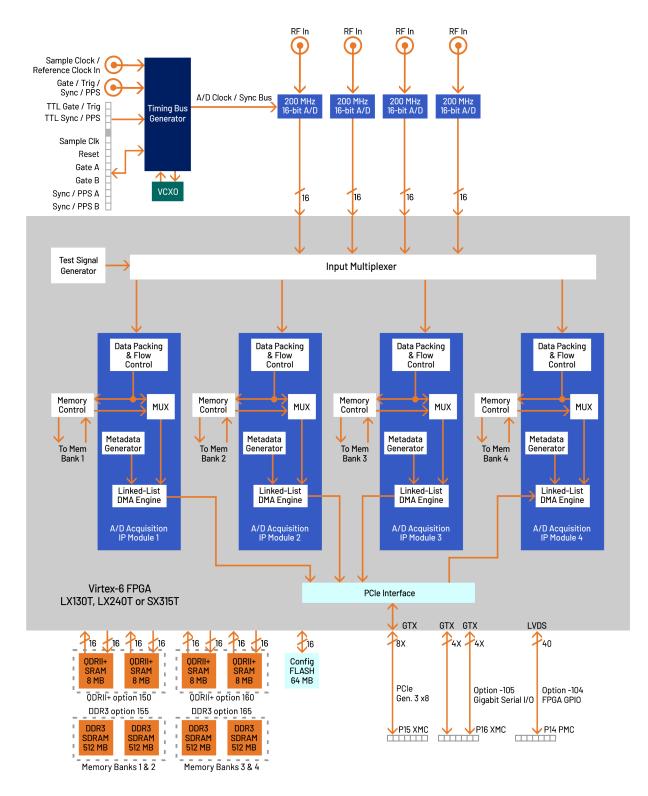
It includes four A/Ds and four banks of memory. In addition to supporting PCI Express Gen. 2 as a native interface, the 71660 includes general purpose and gigabit serial connectors for application-specific I/O.

FEATURES

- Supports Xilinx[®] Virtex[®]-6 LXT and SXT FPGA
- Four 200 MHz 16-bit A/Ds
- Up to 2 GB of DDR3 SDRAM or 32 MB of QDRII+ SRAM
- Sample clock synchronization to an external system reference
- LVPECL clock/sync bus for multimodule synchronization
- PCI Express (Gen. 1 & 2) interface up to x8
- VITA 42.0 XMC compatible with switched fabric interfaces
- Optional user-configurable gigabit serial interface
- Optional LVDS connections to the Virtex-6 FPGA for custom I/O

71660 BLOCK DIAGRAMS

Click on a block for more information.



THE COBALT ARCHITECTURE

Each member of the Cobalt family is delivered with factory-installed applications ideally matched to the board's analog interfaces. The 71660 factory-installed functions include four A/D acquisition IP modules. IP modules for either DDR3 or QDRII+ memories, a controller for all data clocking and synchronization functions, a test signal generator, and a PCIe interface complete the factory-installed functions and enable the 71660 to operate as a complete turnkey solution without the need to develop any FPGA IP.

XILINX VIRTEX-6 FPGA

The Virtex-6 FPGA site can be populated with a variety of different FPGAs to match the specific requirements of the processing task. Supported FPGAs include: LX130T, LX240T, or SX315T. The SXT part features 1344 DSP48E slices and is ideal for

modulation/demodulation,

encoding/decoding, encryption/decryption, and channelization of the signals between transmission and reception. For applications not requiring large DSP resources, one of the lower-cost LXT FPGAs can be installed.

A/D CONVERTER STAGE

The board's analog interface accepts four full-scale analog HF or IF inputs on front panel SSMC connectors at +8 dBm into 50 ohms with transformer coupling into four Texas Instruments ADS5485 200 MHz, 16-bit A/D converters.

The digital outputs are delivered into the Virtex-6 FPGA for signal processing, data capture or for routing to other module resources.

A/D ACQUISITION MODULES

The 71660 features four A/D Acquisition IP Modules for easily capturing and moving data. Each IP module can receive data from any of the four A/Ds or a test signal generator.

Each IP module has an associated memory bank for buffering data in FIFO mode or for storing data in transient capture mode. All memory banks are supported with DMA engines for easily moving A/D data through the PCIe interface. These powerful linkedlist DMA engines are capable of a unique Acquisition Gate Driven mode. In this mode, the length of a transfer performed by a link definition need not be known prior to data acquisition; rather, it is governed by the length of the acquisition gate. This is extremely useful in applications where an external gate drives acquisition and the exact length of that gate is not known or is likely to vary.

For each transfer, the DMA engine can automatically construct metadata packets containing A/D channel ID, a sampleaccurate time stamp and data length information. These actions simplify the host processor's job of identifying and executing on the data.

CLOCKING AND SYNCHRONIZATION

An internal timing bus provides all timing and synchronization required by the A/D converters. It includes a clock, two sync and two gate or trigger signals. An onboard clock generator receives an external sample clock from the front panel SSMC connector. This clock can be used directly by the A/D or divided by a built-in clock synthesizer circuit. In an alternate mode, the sample clock can be sourced from an on-board programmable voltage-controlled crystal oscillator. In this mode, the front panel SSMC connector can be used to provide a 10 MHz reference clock for synchronizing the internal oscillator.

A front panel 26-pin LVPECL Clock/Sync connector allows multiple modules to be synchronized. In the slave mode, it accepts LVPECL inputs that drive the clock, sync and gate signals. In the master mode, the LVPECL bus can drive the timing signals for synchronizing multiple modules. Multiple 71660's can be driven from the LVPECL bus master, supporting synchronous sampling and sync functions across all connected boards.

MEMORY RESOURCES

The 71660 architecture supports up to four independent memory banks which can be configured with all QDRII+ SRAM, DDR3 SDRAM, or as combination of two banks of each type of memory.

Each QDRII+ SRAM bank can be up to 8 MB deep and is an integral part of the module's DMA capabilities, providing FIFO memory space for creating DMA packets. For applications requiring deeper memory resources, DDR3 SDRAM banks can each be up to 512 MB deep. Built-in memory functions include multichannel A/D data capture, tagging and streaming.

In addition to the factory-installed functions, custom user-installed IP within the FPGA can take advantage of the memories for many other purposes.

PCI EXPRESS INTERFACE

The 71660 includes an industry-standard interface fully compliant with PCI Express Gen. 1 & 2 bus specifications. Supporting PCIe links up to x8, the interface includes multiple DMA controllers for efficient transfers to and from the board.

XMC INTERFACE

The 71660 complies with the VITA 42.0 XMC specification. Two connectors each provide dual 4X links or a single 8X link with up to a 6 GHz bit clock. With dual XMC connectors, the 71660 supports x8 PCIe on the first XMC connector leaving the second connector free to support user-installed transfer protocols specific to the target application.

READYFLOW

Mercury provides ReadyFlow[®] BSPs (Board Support Packages) for all Cobalt, Onyx, and Flexor products. Available for both Linux and Windows, these packages:

- Provide a path for quick start-up through application completion
- Allow programming at high, intermediate and low levels to meet various needs
- Are illustrated with numerous examples
- Include complete documentation and definitions of all functions
- Include library and example source code.

ReadyFlow BSPs contain C-language examples that can be used to demonstrate the capabilities of Cobalt, Onyx, and Flexor products. These programming examples will help you get an immediate start on writing your own application. They provide sample code that is known to work, giving you a means of verifying that your board set is operational.

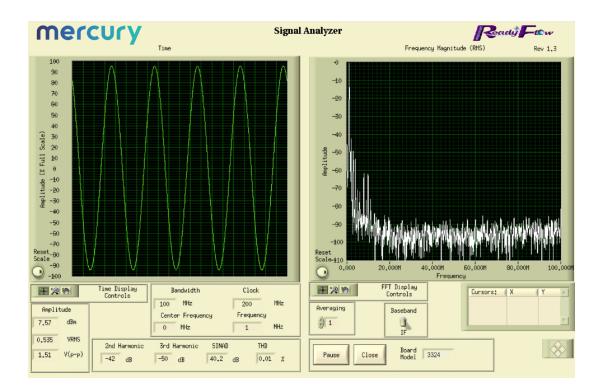
COMMAND LINE INTERFACE

The Command Line Interface provides access to pre-compiled executable examples that operate the hardware right out of the box, without the need to write any code. Board-specific hardware operating arguments can be entered in the command line to control parameters: number of channels to enable, sample clock frequency, data transfer size, reference clock frequency, reference clock source, etc.

The Command Line Interface can be used to call an example application from within a larger user application to control the hardware, and parameter arguments are passed to the application for execution. Functions that control data acquisition automatically save captured data to a pre-named host file or are routed to the Signal Analyzer example function for display.

SIGNAL ANALYZER

When used with the Command Line Interface, the Signal Analyzer allows users to immediately start acquiring and displaying A/D data. A full-featured analysis tool, the Signal Analyzer displays data in time and frequency domains. Built-in measurement functions display 2nd and 3rd harmonics, THD, and SINAD. Interactive cursors allow users to mark data points and instantly calculate amplitude and frequency of displayed signals.



GATEFLOW

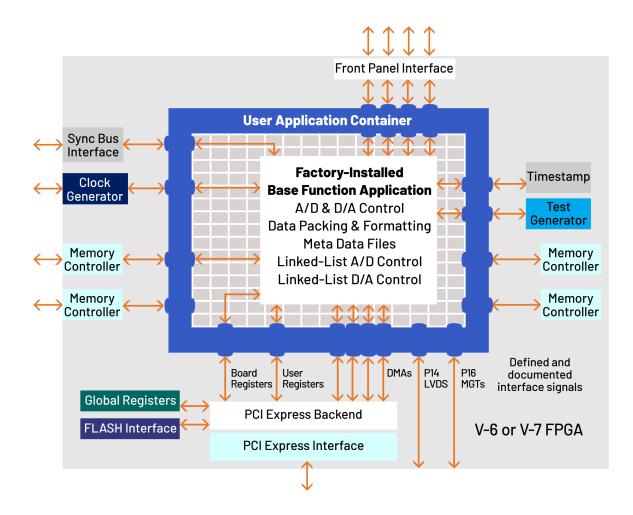
The GateFlow[®] FPGA Design Kit (FDK) allows the user to modify, replace and extend the standard installed functions in the FPGA to incorporate special modes of operation, new control structures, and specialized signal-processing algorithms.

The Cobalt (Virtex-6), Onyx (Virtex-7), and Flexor (Virtex-7) architectures configure the FPGA with standard factory-supplied interfaces including memory controllers, DMA engines, A/D and D/A interfaces, timing and synchronization structures, triggering and gating logic, time stamping and header tagging, data formatting engines, and the PCIe interface. These resources are connected to the User Application Container using well-defined ports that present easy-to-use data and control signals, effectively abstracting the lower-level details of the hardware.

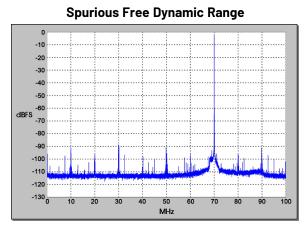
The User Application Container

Shown below is the FPGA block diagram of a typical Cobalt, Onyx or Flexor module. The User Application Container holds a collection of different installed IP modules connected to the various interfaces through the standard ports surrounding the container. The specific IP modules for each product are described in further detail in the datasheet of that product.

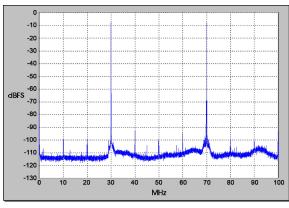
The GateFlow FDK provides a complete Xilinx's ISE or Vivado project folder containing all the files necessary for the FPGA developer to recompile the entire project with or without any required changes. VHDL source code for each IP module provides excellent examples of how the IP modules work, how they might be modified, and how they might be replaced with custom IP to implement a specific function.



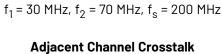
A/D PERFORMANCE

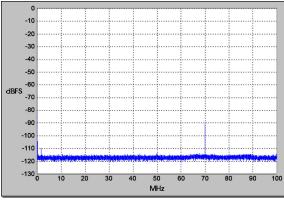


 f_{in} = 70 MHz, f_s = 200 MHz, Internal Clock

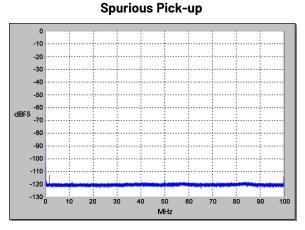


Two-Tone SFDR



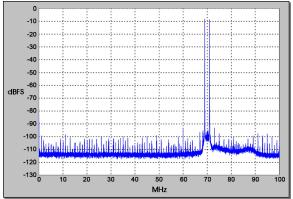


 f_{in} Ch2 = 70 MHz, f_s = 200 MHz, Ch 1 shown



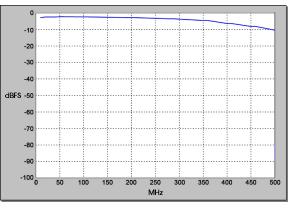
 $f_s = 200 \text{ MHz}$, Internal Clock

Two-Tone SFDR



 $f_1 = 69 \text{ MHz}, f_2 = 71 \text{ MHz}, f_s = 200 \text{ MHz}$

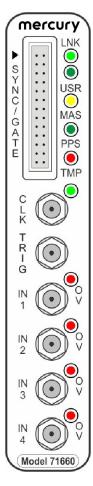
Input Frequency Response



f_s = 200 MHz, Internal Clock

FRONT PANEL CONNECTIONS

The XMC front panel includes six SSMC coaxial connectors, and a 26-pin μ Sync Bus connector for input/output of timing and analog signals. The front panel also includes ten LEDs.



Sync Bus Connector: The 26-pin Sync Bus front panel connector labeled SYNC/GATE provides clock, sync and gate input/output pins for the Low-Voltage Positive Emitter-Coupled Logic (LVPECL) Sync Bus. When the board is a bus master, these pins output LVPECL Sync Bus signals to other slave units. When the board is a bus Slave, these pins input LVPECL signals from a bus Master.

- Link LED: The green LNK LED illuminates when a valid link has been established over the PCIe interface.
- **USR LED:** The green **USR** LED is for user applications.
- Master LED: the yellow MAS
 LED illuminates when this board is the
 Sync Gus Master. When only a single
 board is used, it must be a Master.
- **PPS LED:** the green **PPS** LED illuminates when a valid PPS sign is detected. The LED will blink at the rate of the PPS signal.

Over Temperature LED: The red **TMP** LED illuminates when an over-

temperature or over-voltage condition is indicated by any of the temperature/voltage sensors on the PCB.

- Clock LED: The green CLK LED illuminates when a valid sample clock signal is detected. If the LED is not illuminated, no clock has been detected and no data from the input stream can be processed.
- **Clock Input Connector:** One SSMC coaxial connector, labeled **CLK** for the input of an external sample clock.
- Trigger Input Connector: The front panel has one SSMC coaxial connector, labeled TRIG, for input of an external trigger.
- Analog Input Connectors: Four SSMC coaxial connector, labeled IN 1, IN 2, IN 3, and IN 4 for analog signal inputs, one for each ADC input channel.

• **ADC Overload LEDs:** There are four red **OV** LEDs, one for each A/D input. Use the applicable ADC Date Control Register to select the signal source for each OV LED, either an overload detection in the associated ADS5485, or an ADC FIFO overrun.

SPECIFICATIONS

Front Panel Analog Signal Inputs

Input Type: Transformer-coupled, front panel female SSMC connectors

Transformer Type: Coil Craft WBC4-6TLB

Full Scale Input: +8 dBm into 50 ohms

3 dB Passband: 300 kHz to 700 MHz

A/D Converters

Type: Texas Instruments ADS5485

Sampling Rate: 10 MHz to 200 MHz

Resolution: 16 bits

Sample Clock Sources

On-board clock synthesizer

Clock Synthesizer

Clock Source: Selectable from on-board programmable VCXO (10 to 810 MHz), front panel external clock or LVPECL timing bus

Synchronization: VCXO can be locked to an external 4 to 180 MHz PLL system reference, typically 10 MHz

Clock Dividers: External clock or VCXO can be divided by 1, 2, 4, 8, or 16 for the A/D clock

External Clock

Front panel female SSMC connector, sine wave, 0 to +10 dBm, AC-coupled, 50 ohms, accepts 10 to 800 MHz sample clock or PLL system reference

Timing Bus

26-pin connector LVPECL bus includes, clock/sync/gate/PPS inputs and outputs; TTL signal for gate/ trigger and sync/PPS inputs

External Trigger Input

Type: Front panel female SSMC connector, LVTTL

Function: Programmable functions include: trigger, gate, sync and $\ensuremath{\mathsf{PPS}}$

Field Programmable Gate Array

Standard: Xilinx Virtex-6 XC6VLX130T

Optional: Xilinx Virtex-6 XC6VLX240T or XC6VSX315T

Custom I/O

- Option -104: Installs the PMC P14 connector with 20 LVDS pairs to the FPGA
- Option -105: Installs the XMC P16 connector configurable as one 8X or two 4X gigabit serial links to the FPGA

Memory

- Option 150 or 160: Two 8 MB QDRII+ SRAM memory banks, 400 MHz DDR
- Option 155 or 165: Two 512 MB DDR3 SDRAM memory banks, 400 MHz DDR

PCI Express Interface

PCI Express Bus: Gen. 1: x4 or x8; Gen.2: x4

Environmental

Standard: L0 (air-cooled)

- Operating Temp: 0° to 50° C
- Storage Temp: -20° to 90° C
- Relative Humidity: 0 to 95%, non-condensing

Option -702: L2 (air-cooled)

- Operating Temp: -20° to 65° C
- Storage Temp: -40° to 100° C
- Relative Humidity: 0 to 95%, non-condensing

Option -713: L3 (conduction-cooled)

- Operating Temp: -40° to 70° C
- Storage Temp: -50° to 100° C
- Relative Humidity: 0 to 95%, non-condensing

Physical

Dimensions: Standard XMC module

- Depth: 149.0 mm (5.87 in.)
- Height: 74 mm (2.91 in.)

Weight: Approximately 14 oz. (400 grams)

ORDERING INFORMATION

Model	Description
71660	4-Channel 200 MHz A/D with Virtex-6 FPGA - XMC
71660G	RoHS version, contact factory

Options	Description	
-062	XC6VLX240T FPGA	
-064	XC6VSX315T FPGA	
-104	LVDS FPGA I/O through P14 connector	
-105	Gigabit serial FPGA I/O through P16 connector	
-150	Two 8 MB QDRII+ SRAM Memory Banks (Banks 1 and 2)	
-155	Two 512 MB DDR3 SDRAM Memory Banks (Banks 1 and 2)	
-160	Two 8 MB QDRII+ SRAM Memory Banks (Banks 3 and 4)	
-165	Two 512 MB DDR3 SDRAM Memory Banks (Banks 3 and 4)	
-702	Air-cooled, Level 2	
-713	Conduction-cooled, Level 3	
-730	2-slot heat sink	
Contact Mercury for compatible option combinations.		

ACCESSORY PRODUCTS

Model	Description
2171	Cable Kit: SSMC to SMA

FORM FACTORS

Cobalt products are available in standard form factors including 3U VPX, 6U VPX, PCIe, and XMC. The Cobalt Model 71660 XMC (4-Channel 200 MHz, 16-bit A/D with Virtex-6 FPGA) has the following variants:

Model	
52660	3U VPX board (single XMC)
57660	6U VPX board (single XMC)
58660	6U VPX board (dual XMC)
71660	XMC module
78660	PCIe board (single XMC)

DEVELOPMENT SYSTEMS

Mercury offers development systems for Cobalt products. They come with all pre-tested software and hardware ready for immediate operation. These systems are intended to save engineers and system integrators the time and expense associated with building and testing a development system that ensures optimum performance of Cobalt boards. Please contact Mercury to configure a system that matches your requirements.

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